

DuraForm® HST Composite

Selective Laser Sintering (SLS)

A fiber-reinforced material with an ideal mix of stiffness, strength and high temperature resistance.

General Properties

| MEASUREMENT | CONDITION | METRIC | U.S. |
|--------------------------|-----------|--------|------|
| Specific Gravity (g/cm³) | ASTM D792 | 1.20 | 1.20 |

Mechanical Properties

| MEASUREMENT | CONDITION | METRIC | U.S. |
|--|------------|-----------|-------------|
| Tensile Strength Ultimate (MPa psi) | ASTM D 638 | 48-51 | 7050-7350 |
| Tensile Modulus (MPa ksi) | ASTM D 638 | 5475-5725 | 795-831 |
| Elongation at Break (%) | ASTM D 638 | 4.5 | 4.5 |
| Flexural Strength, Ultimate (MPa psi) | ASTM D 790 | 83-89 | 12000-12900 |
| Flexural Modulus (MPa ksi) | ASTM D 790 | 4400-4550 | 638-660 |
| Hardness, Shore D | ASTM D2240 | 75 | 75 |
| Impact Strength (J/m ft-lb/in) (notched Izod, 23°C) | ASTM D256 | 37.4 | 0.7 |
| Impact Strength (J/m ft-lb/in) (unnotched Izod, 23°C) | ASTM D256 | 310 | 5.8 |
| Gardner Impact (J ft-lb) | ASTM D5420 | 5 | 3.7 |

Data was generated by building parts using 100% virgin powder under typical default parameters. DuraForm HST Composite was processed on a Sinterstation® HiQ $^{\text{m}}$ + HS SLS System at 25 watts laser power, 10 m/sec [400 inches/sec] scan speed, and a powder layer thickness of 0.1 mm [0.004 inches].

Features

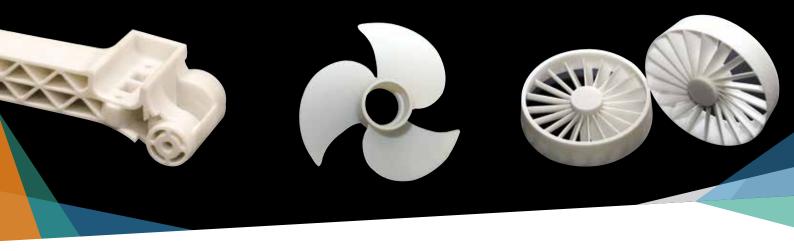
- High specific stiffness
- Elevated temperature resistance
- Anisotropic mechanical properties just like fiber-filled, injection molded materials
- Non-conductive and RF transparent
- Easy-to-finish surface

Benefits

- Functional prototypes can be tested in "real life" environments
- Complex end-use parts can be economically manufactured in low-to-medium volumes
- Excels in load-bearing applications at higher temperatures
- Attractive surface finish

Applications

- Functional prototypes and end-use parts that require high stiffness and/or elevated thermal resistance
- Typical Applications include:
 - UAV structural components
 - Housings and enclosures
 - Impellers
 - Connectors
 - Consumer sporting goods



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Thermal Properties

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|--|--|------------------|------------------|
| Heat Deflection Temperature | ASTM D 648 @ 0.45 MPa @ 1.82 MPa | 184 °C 179 °C | 363 °F 355 °F |
| Coefficient of Thermal Expansion (μm/m-°C μm/in-°F) | ASTM E 831 0-50 °C 85-145 °C | 138.3 267.2 | 76.8 148.4 |
| Specific Heat Capacity (J/g-°C BTU/lb-°F) | ASTM E1269 | 1.64 | 0.392 |
| Thermal Conductivity (W/m-K BTU-in/hr-ft²-°F) | ASTM E1225 | 1.503 | 0.359 |
| Flammability | UL 94 | НВ | НВ |

Electrical Properties

| MEASUREMENT | CONDITION | METRIC | U.S. |
|-------------------------------------|-----------|------------------------|------------------------|
| Volume Resistivity (ohm-cm) | ASTM D257 | 6.7 X 10 ¹⁵ | 6.7 X 10 ¹⁵ |
| Surface Resistivity (ohm) | ASTM D257 | 5.2 X 10 ¹⁵ | 5.2 X 10 ¹⁵ |
| Dissipation Factor, 1 KHz | ASTM D150 | 0.028 | 0.028 |
| Dielectric Constant, 1 KHz | ASTM D150 | 3.14 | 3.14 |
| Dielectric Strength (kV/mm kV/in) | ASTM D149 | 18.5 | 470 |

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